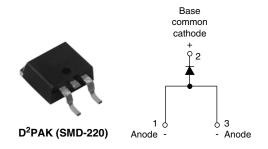




Vishay High Power Products

Fast Soft Recovery Rectifier Diode, 20 A



PRODUCT SUMMARY						
V _F at 20 A < 1.31 V						
I _{FSM}	355 A					
V _{RRM}	800 V to 1200 V					

FEATURES/DESCRIPTION

The 20ETF..SPbF fast soft recovery rectifier series has been optimized for combined short reverse recovery time and low forward voltage drop.



The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.

This product series has been designed and qualified for industrial level.

Compliant to RoHS directive 2002/95/EC.

Halogen-free according to IEC 61249-2-21 definition.

APPLICATIONS

- Output rectification and freewheeling in inverters, choppers and converters
- Input rectifications where severe restrictions on conducted EMI should be met

MAJOR RATINGS AND CHARACTERISTICS									
SYMBOL	CHARACTERISTICS	VALUES	UNITS						
I _{F(AV)}	Sinusoidal waveform	20	A						
V _{RRM}		800 to 1200	V						
I _{FSM}		355	A						
V _F	20 A, T _J = 25 °C	1.31	V						
t _{rr}	1 A, 100 A/µs	95	ns						
T _J	Range	- 40 to 150	°C						

VOLTAGE RATINGS									
PART NUMBER	V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I _{RRM} AT 150 °C mA						
20ETF08SPbF	800	900							
20ETF10SPbF	1000	1100	6						
20ETF12SPbF	1200	1300							

ABSOLUTE MAXIMUM RATINGS								
PARAMETER	TEST CONDITIONS	VALUES	UNITS					
Maximum average forward current I _{F(AV)}		T _C = 97 °C, 180° conduction half sine wave	20					
Maximum peak one cycle	I _{FSM}	10 ms sine pulse, rated V _{RRM} applied	300	Α				
non-repetitive surge current		10 ms sine pulse, no voltage reapplied	355					
Maximum I ² t for fusing	I ² t	10 ms sine pulse, rated V _{RRM} applied	450	A ² s				
Maximum i-t for fusing		10 ms sine pulse, no voltage reapplied	lse, no voltage reapplied 635					
Maximum I ² √t for fusing	I²√t	t = 0.1 ms to 10 ms, no voltage reapplied	6350	A²√s				

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

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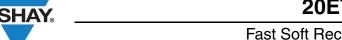
ELECTRICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CO	VALUES	UNITS				
Maximum forward voltage drop	V_{FM}	20 A, T _J = 25 °C	1.31	V				
Forward slope resistance	r _t	T _{.1} = 150 °C	11.88	mΩ				
Threshold voltage	V _{F(TO)}	1j=150 C	0.93	V				
Maximum rayaraa laakaga aurrant	1	T _J = 25 °C	V _B = Rated V _{BBM}	0.1	A			
Maximum reverse leakage current	I _{RM}	T _J = 150 °C	V _R = naleu V _{RRM}	6	mA			

RECOVERY CHARACTERISTICS									
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	· •				
Reverse recovery time	t _{rr}	I _F at 20 Apk	400	ns	I _{FM} t				
Reverse recovery current	I _{rr}	25 A/μs	6.1	Α	$t_a \mid t_b$				
Reverse recovery charge	Q _{rr}	25 °C	1.7	μC	dir/ dt Q,,				
Snap factor	S	Typical	0.6		I _{RM(REC)}				

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum junction and storage temperature range	T _J , T _{Stg}		- 40 to 150	°C				
Maximum thermal resistance, junction to case	R _{thJC}	DC operation	0.9	°C/W				
Maximum thermal resistance, junction to ambient (PCB mount)	R _{thJA} (1)		62	C/ VV				
Soldering temperature	T _S		240	°C				
Approximate weight			2	g				
Approximate weight			0.07	oz.				
			20ETF08S					
Marking device		Case style D ² PAK (SMD-220)	20ETF10S					
			20ETF12S					

Note

⁽¹⁾ When mounted on 1" square (650 mm²) PCB of FR-4 or G-10 material 4 oz. (140 μm) copper 40 °C/W For recommended footprint and soldering techniques refer to application note #AN-994



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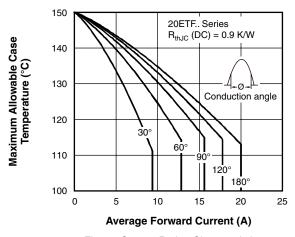


Fig. 1 - Current Rating Characteristics

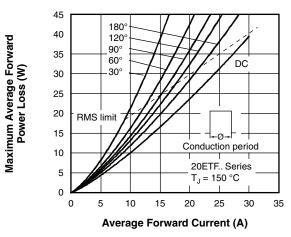


Fig. 4 - Forward Power Loss Characteristics

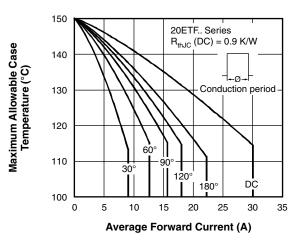


Fig. 2 - Current Rating Characteristics

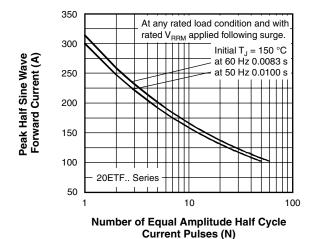


Fig. 5 - Maximum Non-Repetitive Surge Current

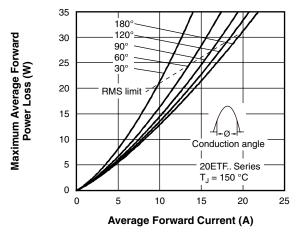


Fig. 3 - Forward Power Loss Characteristics

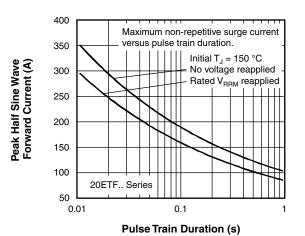


Fig. 6 - Maximum Non-Repetitive Surge Current

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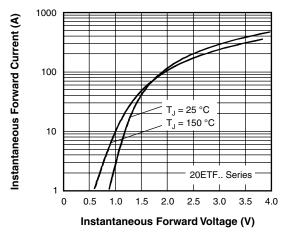


Fig. 7 - Forward Voltage Drop Characteristics

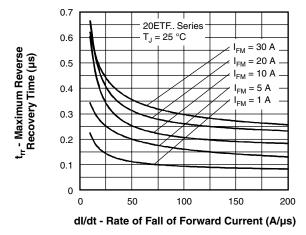


Fig. 8 - Recovery Time Characteristics, T_J = 25 °C

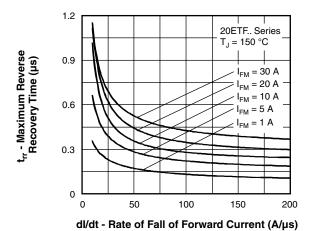


Fig. 9 - Recovery Time Characteristics, T_J = 150 °C

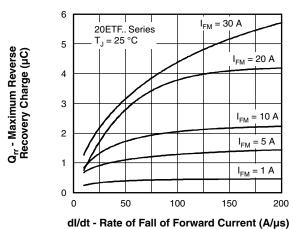


Fig. 10 - Recovery Charge Characteristics, T_J = 25 °C

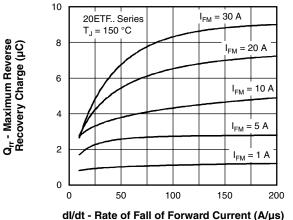
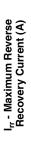
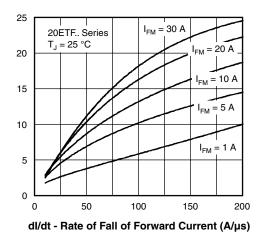


Fig. 11 - Recovery Charge Characteristics, T_J = 150 °C

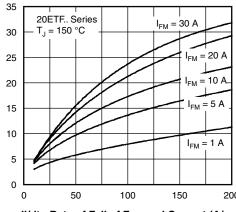


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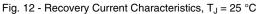




Irr - Maximum Reverse Recovery Current (A)



dl/dt - Rate of Fall of Forward Current (A/µs) Fig. 13 - Recovery Current Characteristics, T_J = 150 °C



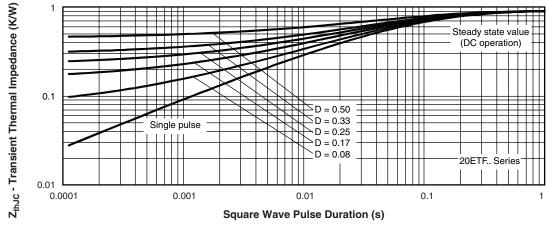


Fig. 14 - Thermal Impedance Z_{thJC} Characteristics

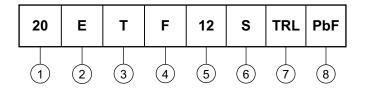
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Fast Soft Recovery Rectifier Diode, 20 A



ORDERING INFORMATION TABLE

Device code



1 - Current rating (20 = 20 A)

2 - Circuit configuration:

E = Single diode

3 - Package:

 $T = D^2PAK (TO-220AC)$

4 - Type of silicon:

F = Fast soft recovery rectifier

08 = 800 V 10 = 1000 V

Voltage code x 100 = V_{RRM}
S = Surface mountable

12 = 1200 V

7 - • None = Tape

• TRR = Tape and reel (right oriented)

• TRL = Tape and reel (left oriented)

8 - • None = Standard production

• PbF = Lead (Pb)-free

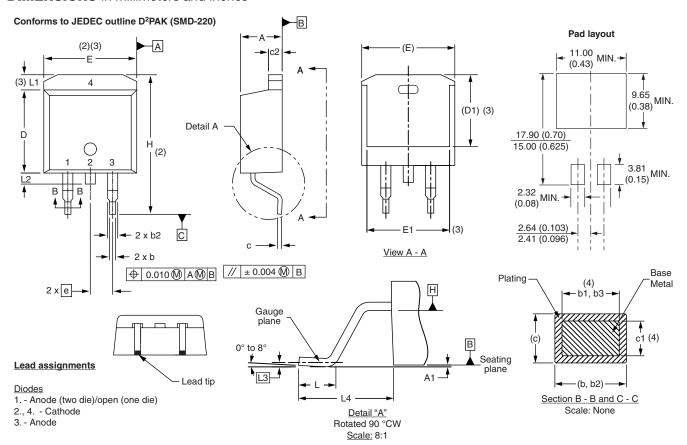
LINKS TO RELATED DOCUMENTS							
Dimensions	www.vishay.com/doc?95046						
Part marking information	www.vishay.com/doc?95054						
Packaging information	www.vishay.com/doc?95032						



Vishay Semiconductors

D²PAK

DIMENSIONS in millimeters and inches



SYMBOL	MILLIN	MILLIMETERS		INCHES		NOTES	SYMBOL	MILLIM	ETERS	INC	HES
STWBOL	MIN.	MAX.	MIN.	MAX.	NOTES	NOTES	STINIBUL	MIN.	MAX.	MIN.	MAX.
Α	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315
A1	0.00	0.254	0.000	0.010			E	9.65	10.67	0.380	0.420
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346
b1	0.51	0.89	0.020	0.035	4		е	2.54	BSC	0.100	BSC
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070
c2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010	BSC
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208

Notes

- $^{(1)}$ Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC outline TO-263AB

NOTES

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2, 3

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